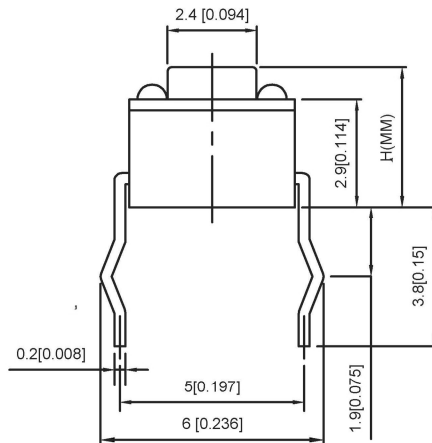
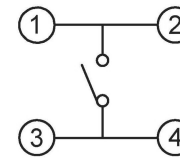
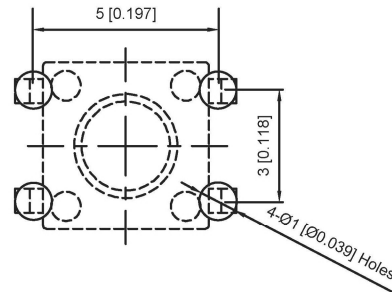
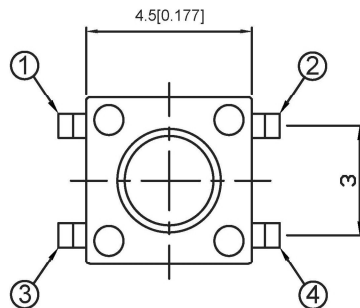


CIRCUIT DIAGRAM



Code-x	H
A	3.8
B	4.3
C	4.5
D	5.0
E	5.5
F	6.0
G	6.5
H	7.0
I	7.5
J	8.0
K	8.5
L	9.0

P.C.B MOUNTING PATTERN DIMENSION
The following soldering patterns are recommended for reflow soldering



SPECIFICATION

Contact Rating: 50mA, 12V DC
Contact Resistance: 100mΩ max
Insulation Resistance: 100mΩ min. 500V DC
Dielectric Strength: 250V AC/1minute
Travel: 0.25mm
Operating Temp: -30℃ ~ +85℃
Storage Temp: -30℃ ~ +80℃

PAPT NO	TC-1109-X-X
Operating Force	A: 100gf B: 160gf C: 260gf
Height	Code-X

⑤	Terminal	—	4	Brass (0.30t)	Plating silvering	—
④	Contact	—	1	F.ag/Sus	Natural	—
③	Base	—	1	Pa46	—	—
②	Cover	—	1	Spcc	Plating Nickel	—
①	Keystake	—	1	Pa46	—	—
ITEM	PAPT NAME	TER.NO	QTY	MATERIAL	FINISHING	REMARK

DSND		DATE		SCALE: N/A	MODEL TYPE: TACT SWITCH
DWN		DATE		VIEW:	PART NO.:
CHKD		DATE		UNIT: mm/in	DWG NO.:
APPD		DATE		SIZE: A4	TC-1109-X-X
DONG GUAN XI BANG ELECTRONIC CO., LTD					WEIGHT 1.0g
					SHEET 1/1
					REVISION A0

ΔX					units: mm
ΔX					tolerance:
ΔX					X.X ±0.2mm
MARK	DESCRIPTION	DATE	REVISED	APPROVED	X.XX ±0.1mm
REVISIONS					X.XXX ±0.05mm
UNSPECIFIED TOLERANCES					
www.alpsr.com www.gdxjdz.com www.xbswitch.com					